LNJ316C8TRA

Surface Mounting Chip LED

Microlens Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Symbol Rating		
Power dissipation	P_{D}	60	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

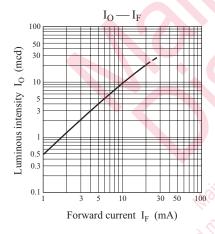
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

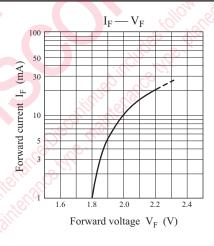
■ Lighting Color

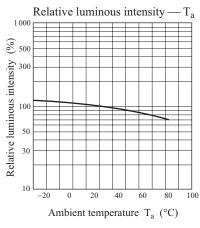
• Yellow Green

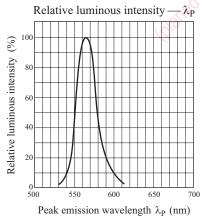
■ Electro-Optical Characteristics $T_a = 25$ °C

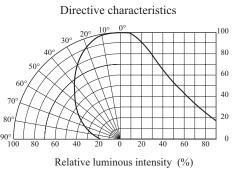
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_F = 10 \text{ mA}$		3.3	8.8	5	mcd
Reverse current	I_R	$V_R = 4 V$		(, ¢t)	"10 _{80"}	10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	X	100,00	2.03	2.6	V
Peak emission wavelength	λ_{P}	$I_F = 10 \text{ mA}$, our	dillo	565		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	99 ji 00 ji	30,	30		nm

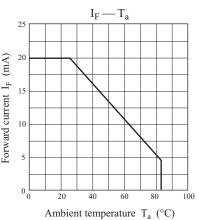










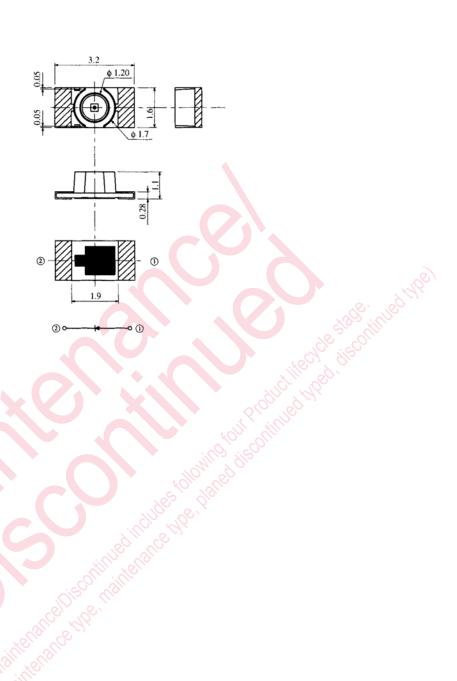


LNJ316C8TRA Panasonic

■ Package (Unit: mm)

Pin name1: Anode2: Cathode

KLTLTN2K1600



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